

Customer Code : _____

DATASHEET

DAPU P/N: **DPBA1000004**

Plot			The Label
Drew	Audited	Approved	Stamp, please! Thanks!
Date: 2019.10.15			

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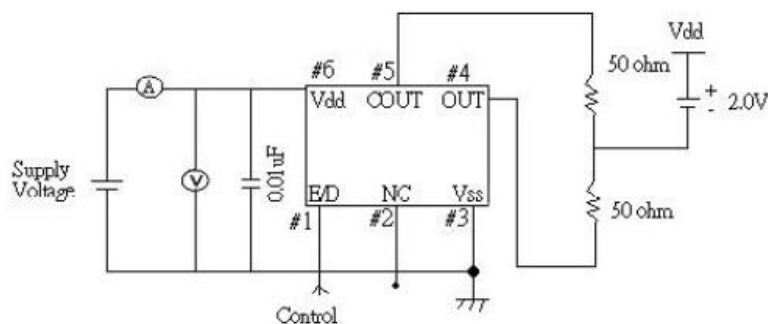
TEL: 0086-0769-88010888 FAX: 0086-0769-81800098



、 Electrical Parameters

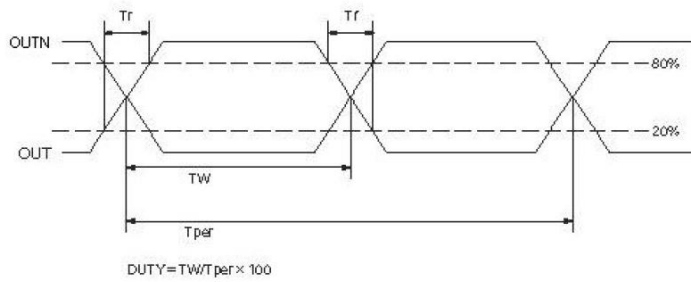
MODEL: DPBA1000004							
No.	Parameters	SYM.	Electrical Spec.				Notes
			Min.	Typ.	Max.	Units	
1	Nominal Frequency	FL	100.00			MHz	
2	Output Waveform		LVPECL				
3	Supply Voltage		3.135	3.3	3.465	V	
4	Frequency Stability	F-stab	-50		+50	$\times 10^{-6}$	Inclusive of initial tolerance, operating temperature, rated power supply voltage, and load variations
5	Operating Temperature	T-opr	-40	~	+85	$^{\circ}\text{C}$	
6	Storage Temperature	T-stg	-55	~	+125	$^{\circ}\text{C}$	
7	Aging(year)		-3		+3	$\times 10^{-6}$	
8	Current Consumption	I _{dd}	-		80	mA	
9	Output Load				50	Ω	VDD-2.0V
10	Rise/Fall Time	Tr、Tf			1	ns	20%~80% output swing level
11	Duty Cycle	DC	45		55	%	
12	Output Voltage High	VOH	2.275			V	
13	Output Voltage Low	VOL			1.680	V	
14	Start up Time	T _{start}	-		10	ms	
15	Phase Jitter RMS				1	ps	12KHz-40MHz
16	Phase Jitter RMS		-		0.17	ps	10KHz-1MHz
17	Shock	Free Drop from 75cm height on a hard wood board for 3 time.					
	Vibration	10~55Hz 1.5mm p-p 1~2min/CICLE,X,Y,Z 2H for each plane					
	Aging	85 $^{\circ}\text{C} \pm 3^{\circ}\text{C}$ 720H(No BIAS)					
	High Humidity	40 $^{\circ}\text{C} \pm 2^{\circ}\text{C}$ X 90%-95% 96H(No BIAS)					
	Temperature Cycle	-40 $^{\circ}\text{C}$ ~85 $^{\circ}\text{C}$,30min X 10 Cycle					
	Solderability	MIL-STD-202,Method 208					

2、 Test Circuit

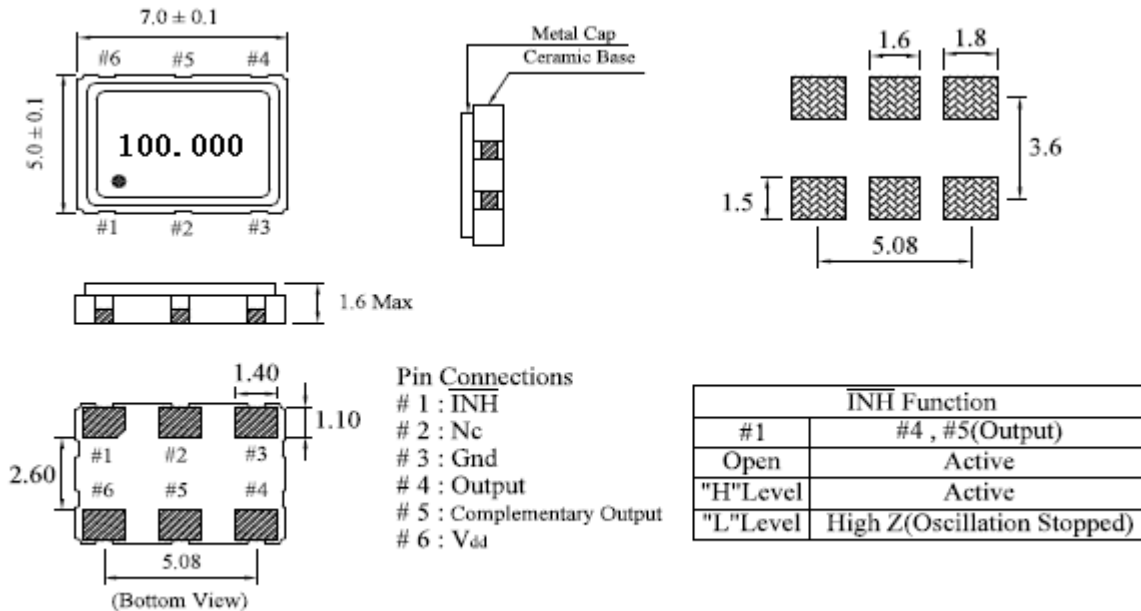




3、 Output Waveform



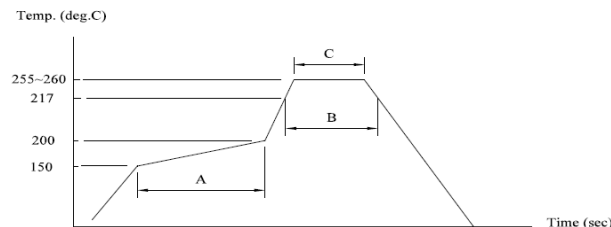
4、 Mechanical Structure(mm)



unit: mm

Note1:Tolerance ±0.2mm without mark

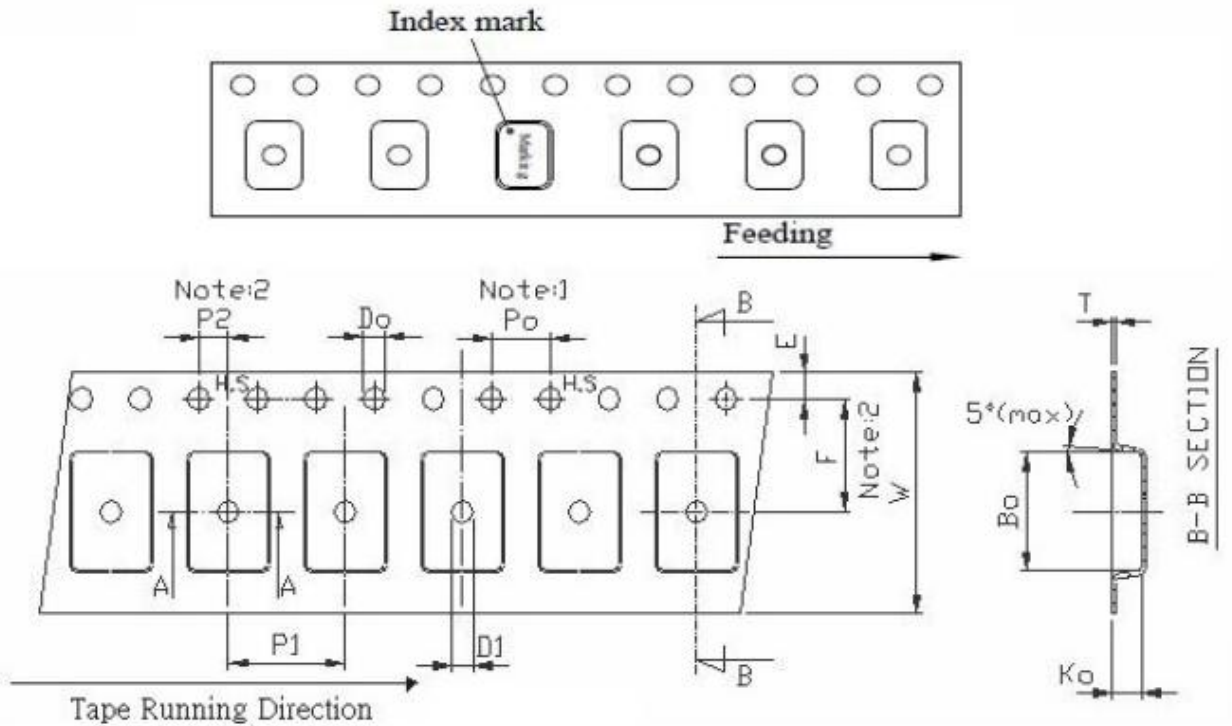
5、 Reflow Soldering Curve (RoHS)



(A)→Preheating area : 150~200°C, 60~120sec.
 (B)→Heating area : 217°C, 60~150sec.
 (C)→Peak temperature : 255~260°C, 30sec. Max.
 Ramp-up rate (217→260°C) : 3°C/sec. Max.
 Ramp-down rate (260→217°C) : 6°C/sec. Max.
 Time 25°C→260°C : 480sec. Max.
 *Reference JEDEC J-STD-020

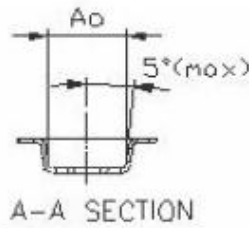


6、 Package: Tape & Reel (mm)



Unit: mm

Symbol	Spec.
K1	-
Po	4.00±0.10
P1	8.00±0.10
P2	2.00±0.10
Do	1.50 ^{+0.1} ₀
D1	1.50(min)
E	1.75±0.10
F	7.50±0.10
10Po	40.0±0.10
W	16.0±0.30
T	0.30±0.05



$Ao = \underline{5.40 \pm 0.10} \text{ mm}$
 $Bo = \underline{7.40 \pm 0.10} \text{ mm}$
 $Ko = \underline{1.90 \pm 0.10} \text{ mm}$

Notice:

1. Sprocket hole pitch cumulative tolerance is ±0.10 mm
2. Packet position relative to sprocket hole measured as true position of packet not pocket hole.
3. Ao & Bo measured on a place 0.3mm above the bottom of the packet to top surface of the carrier.
4. Ko measured from a plane on the inside bottom of the packet to the top surface of the carrier.
5. Carrier camber shall be not than 1mm per 100mm through a length of 250mm.